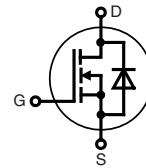


# CoolMOS<sup>TM</sup> 1) Power MOSFET

## ISOPLUS<sup>TM</sup> Package

N-Channel Enhancement Mode  
Low  $R_{DS(on)}$ , high  $V_{DSS}$  MOSFET  
Electrically Isolated Back Surface

$I_{D25} = 25 \text{ A}$   
 $V_{DSS} = 800 \text{ V}$   
 $R_{DS(on)\max} = 150 \text{ m}\Omega$



ISOPLUS220

COOLMOS<sup>TM</sup>  
Power Semiconductors

E72873

### MOSFET

Symbol	Conditions	Maximum Ratings		
$V_{DSS}$	$T_{VJ} = 25^\circ\text{C}$	800	V	
$V_{GS}$		$\pm 20$	V	
$I_{D25}$	$T_C = 25^\circ\text{C}$	25	A	
$I_{D90}$	$T_C = 90^\circ\text{C}$	18	A	
$E_{AS}$	$T_{J\text{ start}} = 25^\circ\text{C}$ ; single pulse; $I_D = 3.4 \text{ A}$	670	mJ	
$E_{AR}$	$T_{J\text{ start}} = 25^\circ\text{C}$ ; repetitive; $I_D = 17 \text{ A}$	0.5	mJ	
$dV/dt$	$V_{DS} < V_{DSS}$ ; $I_F = 35 \text{ A}$ ; $T_{VJ} = 150^\circ\text{C}$ $dI_R/dt = 100 \text{ A}/\mu\text{s}$	6	V/ns	

### Symbol Conditions Characteristic Values

(T<sub>VJ</sub> = 25°C, unless otherwise specified)

		min.	typ.	max.	
$R_{DSon}$	$V_{GS} = 10 \text{ V}$ ; $I_D = I_{D90}$	135	150	$\text{m}\Omega$	
$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ ; $I_D = 2 \text{ mA}$	2		4	V
$I_{DSS}$	$V_{DS} = V_{DSS}$ ; $V_{GS} = 0 \text{ V}$			50	$\mu\text{A}$
	$T_{VJ} = 25^\circ\text{C}$			250	$\mu\text{A}$
	$T_{VJ} = 125^\circ\text{C}$				
$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}$ ; $V_{DS} = 0 \text{ V}$		$\pm 200$		nA
$C_{iss}$ $C_{oss}$ $C_{rss}$	$\left. \begin{array}{l} V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz} \end{array} \right\}$	4600 2500 120			pF pF pF
$Q_g$ $Q_{gs}$ $Q_{gd}$	$\left. \begin{array}{l} V_{GS} = 0 \text{ to } 10 \text{ V}; V_{DS} = 640 \text{ V}; I_D = I_{D90} \end{array} \right\}$	180 20 80			nC nC nC
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$\left. \begin{array}{l} V_{GS} = 10 \text{ V}; V_{DS} = 640 \text{ V}; T_{VJ} = 125^\circ\text{C} \\ I_D = 35 \text{ A}; R_G = 2.2 \Omega \end{array} \right\}$	25 25 75 10			ns ns ns ns
$R_{thJC}$			0.5	K/W	

### Features

- Silicon chip on Direct-Copper-Bond substrate
  - high power dissipation
  - isolated mounting surface
  - 2500 V electrical isolation
- 3<sup>rd</sup> generation CoolMOS<sup>TM</sup> 1) power MOSFET
  - high blocking capability
  - lowest resistance
  - avalanche rated for unclamped inductive switching (UIS)
- Low thermal resistance due to reduced chip thickness
- Low drain to tab capacitance (<30 pF)

### Applications

- Switched mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)
- Power factor correction (PFC)
- Welding
- Inductive heating

### Advantages

- Easy assembly: no screws or isolation foils required
- Space savings
- High power density

<sup>1)</sup> CoolMOS<sup>TM</sup> is a trademark of Infineon Technologies AG.

## Source-Drain Diode

## Symbol    Conditions

## Characteristic Values

(T<sub>VJ</sub> = 25°C, unless otherwise specified)

		min.	typ.	max.
I <sub>S</sub>	V <sub>GS</sub> = 0 V			34 A
V <sub>SD</sub>	I <sub>F</sub> = 35 A; V <sub>GS</sub> = 0 V	1.0	1.2	V
t <sub>rr</sub> Q <sub>RM</sub> I <sub>RM</sub>	I <sub>F</sub> = 35 A; -di <sub>F</sub> /dt = 200 A/μs; V <sub>R</sub> = 400 V	550 30 100		ns μC A

## Component

## Symbol    Conditions

## Maximum Ratings

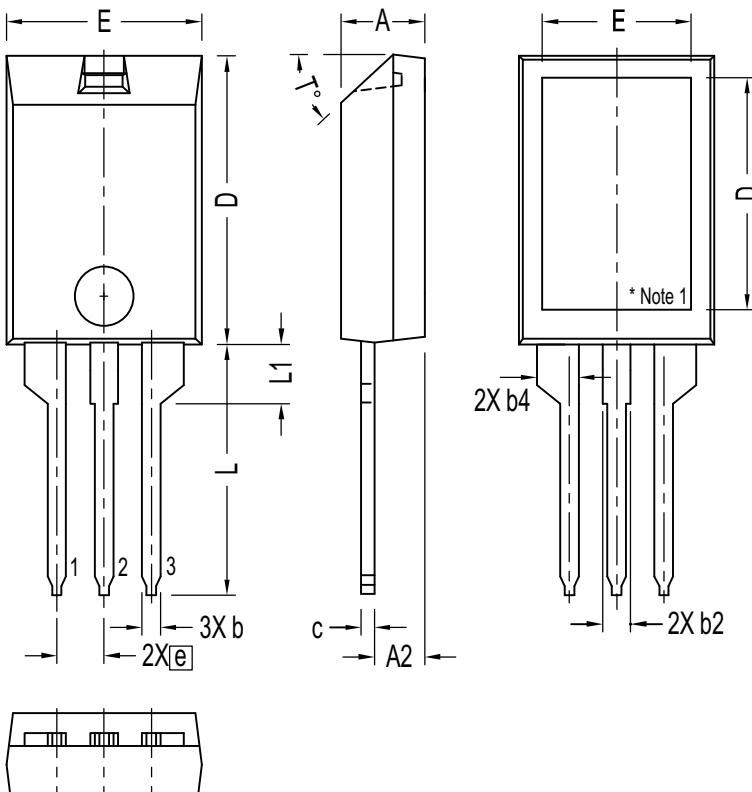
T <sub>VJ</sub>	operating	-55...+150	°C
T <sub>stg</sub>		-55...+150	°C
V <sub>ISOL</sub>	RMS, lead-to-tab, 50/60 Hz, f = 1 minute	2500	V~
F <sub>c</sub>	mounting force	11-65/2.4-11	N/lb.

## Symbol    Conditions

## Characteristic Values

	min.	typ.	max.
R <sub>thCH</sub>	with heatsink compound	0.15	K/W
Weight		2.7	g

## ISOPLUS220™ Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
c	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
e	.100	BASIC	2.55	BASIC
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T°			42.5°	47.5°

## NOTE:

1. Bottom heatsink is electrically isolated from Pin 1, 2, or 3.
2. This drawing will meet dimensional requirement of JEDEC SS Product Outline TO-273 except D and D1 dimension.

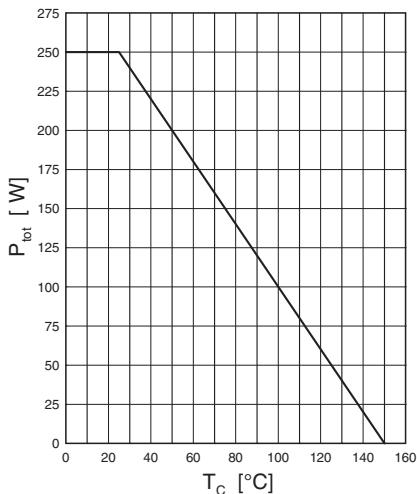


Fig. 1 Power Dissipation

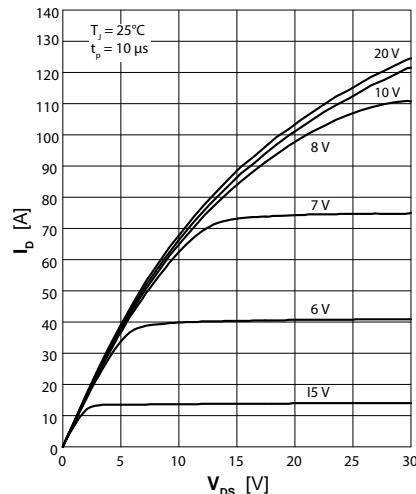


Fig. 2 Typ. Output Characteris-

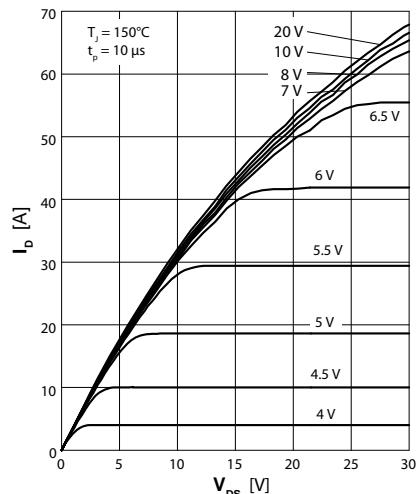


Fig. 3 Typ. Output Characteris-

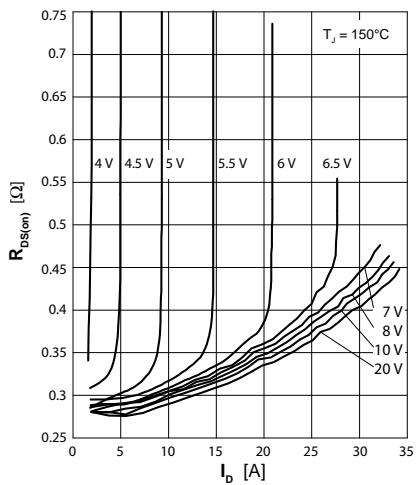


Fig. 4 Typ. Drain-Source on Resistance

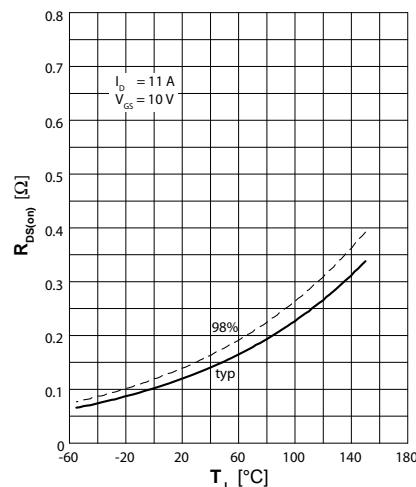


Fig. 5 Drain-Source On-State Resistance

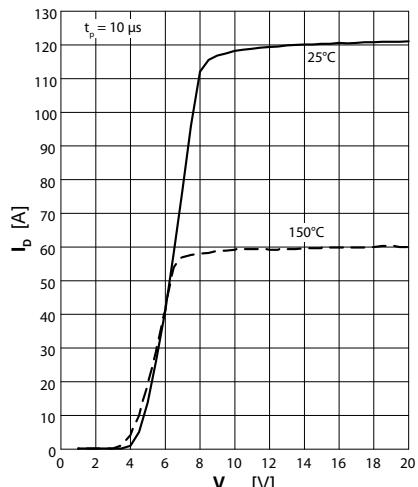


Fig. 6 Typ. Transfer Characteris-

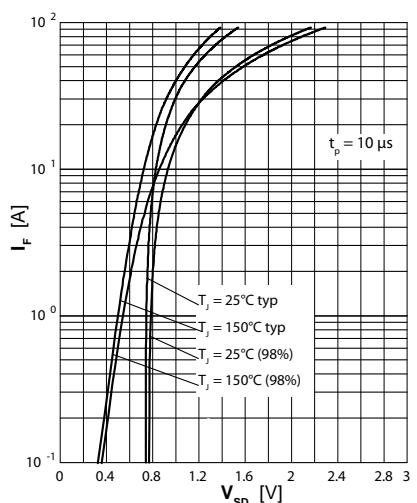


Fig. 7 Forward Characteristics of Body Diode

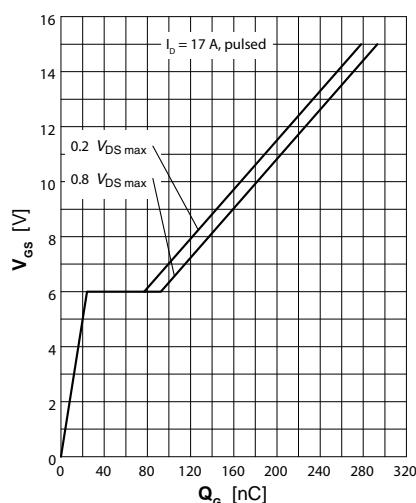


Fig. 8 Typ. Gate Charge

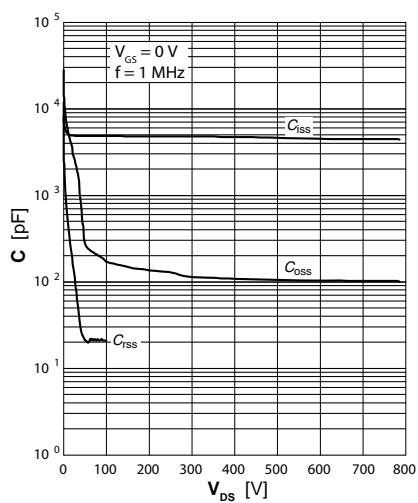


Fig. 9 Capacitance

IXYS reserves the right to change limits, test conditions and dimensions.

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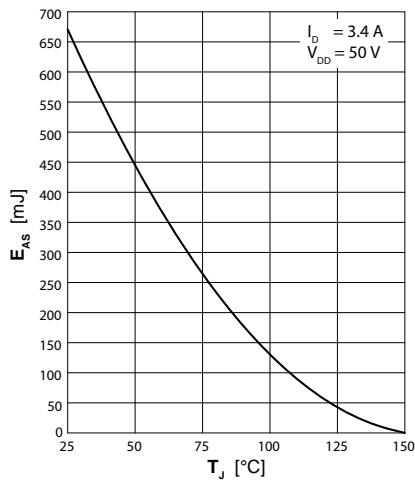


Fig. 10 Typ. Avalanche Energy

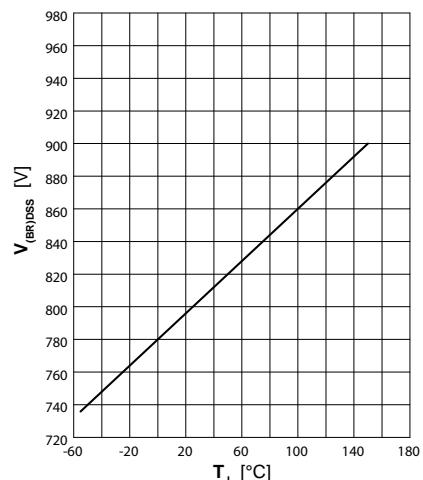


Fig. 11 Drain-Source Breakdown Voltage

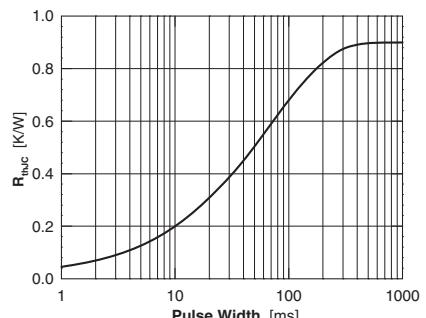


Fig. 12 Maximum Transient Thermal Resistance



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